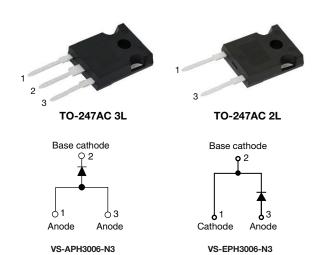
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# VS-APH3006-N3, VS-EPH3006-N3

### **Vishay Semiconductors**

## Hyperfast Rectifier, 30 A FRED Pt<sup>®</sup>



PRIMARY CHAR	PRIMARY CHARACTERISTICS									
I <sub>F(AV)</sub>	30 A									
V <sub>R</sub>	600 V									
V <sub>F</sub> at I <sub>F</sub>	1.4 V									
t <sub>rr</sub> typ.	27 ns									
T <sub>J</sub> max.	175 °C									
Package	TO-247AC 3L, TO-247AC 2L									
Circuit configuration	Single									

#### **FEATURES**

- · Low forward voltage drop
- Hyperfast soft recovery time
- 175 °C operating junction temperature
- · Designed and qualified according to JEDEC<sup>®</sup>-JESD 47



COMPLIANT HALOGEN FREE

 Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **DESCRIPTION / APPLICATIONS**

Hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC Boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

The extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS										
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS						
Repetitive peak reverse voltage	V <sub>RRM</sub>		600	V						
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 112 °C	30	٨						
Non-repetitive peak surge current	I <sub>FSM</sub>	$T_{C} = 25 \text{ °C}, t_{p} = 10 \text{ ms}$	220	A						
Operating junction and storage temperatures	T <sub>J</sub> , T <sub>Stg</sub>		-65 to +175	°C						

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)											
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS					
Breakdown voltage, blocking voltage	V <sub>BR</sub> , V <sub>R</sub>	I <sub>R</sub> = 100 μA	600	-	-						
For and allows	М	I <sub>F</sub> = 30 A	-	2.0	2.65	V					
Forward voltage	V <sub>F</sub>	I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	1.4	1.8						
Poveran lookago ourrent		V <sub>R</sub> = V <sub>R</sub> rated	-	-	30	μA					
Reverse leakage current	IR	$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	300	μΑ					
Junction capacitance	CT	V <sub>R</sub> = 600 V	-	20	-	pF					
Series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body	-	8.0	-	nH					

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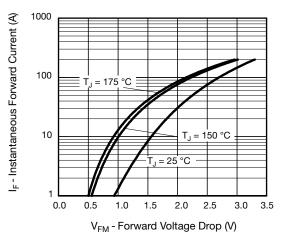


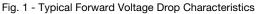
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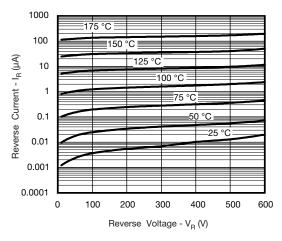
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<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)											
PARAMETER	SYMBOL	TEST C	CONDITIONS	MIN.	TYP.	MAX.	UNITS				
Reverse recovery time		$I_F = 1 \text{ A}, \text{ d}I_F/\text{d}t = 50$	0 Α/μs, V <sub>R</sub> = 30 V	-	26	35					
	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	26	-	ns				
		T <sub>J</sub> = 125 °C		-	70	-					
Pools receivers ourrent	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C	I <sub>F</sub> = 30 A dI <sub>F</sub> /dt = 200 A/µs	-	3.5	-	А				
Peak recovery current		T <sub>J</sub> = 125 °C	$V_{\rm R} = 200 \text{ V}$	-	7.6	-	~				
Reverse recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C	•R - 200 •	-	50	-					
		T <sub>J</sub> = 125 °C		-	280	-	nC				

THERMAL - MECHANI	THERMAL - MECHANICAL SPECIFICATIONS										
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS					
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-65	-	175	°C					
Thermal resistance, junction to case	R <sub>thJC</sub>		-	0.7	1.1	°C/W					
Thermal resistance, junction to ambient per leg	R <sub>thJA</sub>	Typical socket mount	-	-	40						
Thermal resistance, case to heatsink	R <sub>thCS</sub>	Mounting surface, flat, smooth, and greased	-	0.5	-						
W/oight			-	5.5	-	g					
Weight			-	0.2	-	oz.					
Mounting torque			1.2 (10)	-	2.4 (20)	kgf · cm (lbf · in)					
Marking device		Case style TO-247AC 3L	APH3006								
Marking device		Case style TO-247AC 2L	EPH3006								









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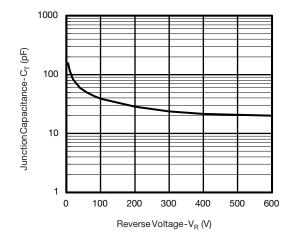
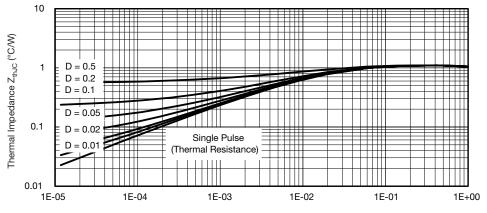
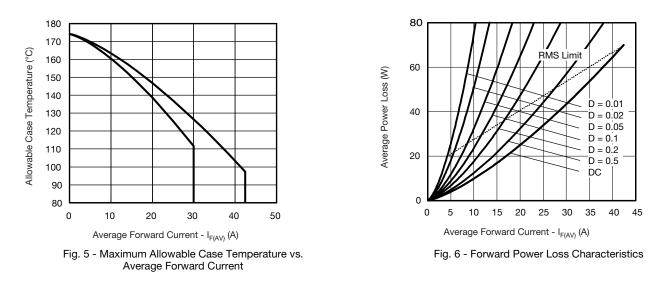


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage



t1, Rectangular Pulse Duration (s)

Fig. 4 - Max. Thermal Impedance ZthJC Characteristics



Revision: 28-Nov-2019

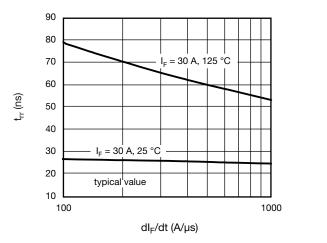
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## VS-APH3006-N3, VS-EPH3006-N3

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Fig. 7 - Typical Reverse Recovery vs. dl<sub>F</sub>/dt

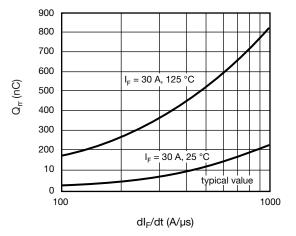


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

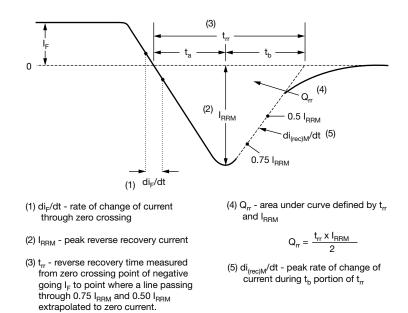


Fig. 9 - Reverse Recovery Waveform and Definitions



# VS-APH3006-N3, VS-EPH3006-N3

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### **ORDERING INFORMATION TABLE**

Device code	VS-	Е	Р	н	30	06	-N3
	1	2	3	4	5	6	7
	1 -	Visł	nay Sem	niconduc	ctors pro	oduct	
	2 -	• E	= single	iguratior diode, 2 diode, 3	2 pins		
	3 -	P =	TO-247	AC			
	4 -	H =	hyperfa	ist recov	ery time	e	
	5 -	Cur	rent cod	le (30 =	30 A)		
	6 -	Volt	age coo	le (06 =	600 V)		
	7 -	Env	rironmer	ntal digit	:		

-N3 = halogen-free, RoHS-compliant and totally lead (Pb)-free

ORDERING INFORMATION (Example)										
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION							
VS-APH3006-N3	25	500	Antistatic plastic tube							
VS-EPH3006-N3	25	500	Antistatic plastic tube							

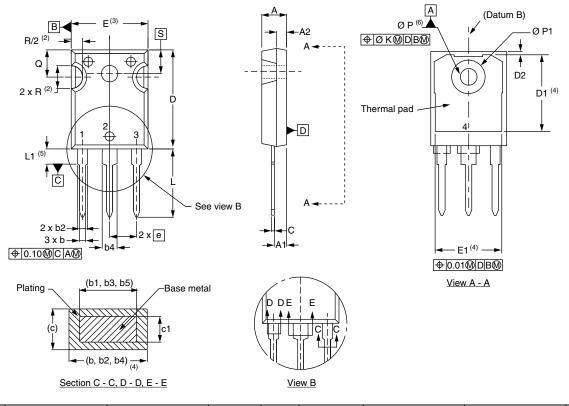
LINKS TO RELATED DOCUMENTS									
Dimensions	TO-247AC 3L	www.vishay.com/doc?96138							
	TO-247AC 2L	www.vishay.com/doc?96144							
Part marking information	TO-247AC 3L	www.vishay.com/doc?95007							
Part marking information	TO-247AC 2L	www.vishay.com/doc?95442							
SPICE model		www.vishay.com/doc?96580							



**Vishay Semiconductors** 

TO-247AC 3L

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	MILLIMETERS		INCHES NOTES		SYMBOL		MILLIN	IETERS	INC	HES	NOTES
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		STWDOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			D2	0.51	1.35	0.020	0.053	
A1	2.21	2.59	0.087	0.102			E	15.29	15.87	0.602	0.625	3
A2	1.17	1.37	0.046	0.054			E1	13.46	-	0.53	-	
b	0.99	1.40	0.039	0.055			е	5.46	BSC	0.215	5 BSC	
b1	0.99	1.35	0.039	0.053			ØK 0.254 0.010		)10			
b2	1.65	2.39	0.065	0.094			L	14.20	16.10	0.559	0.634	
b3	1.65	2.34	0.065	0.092			L1	3.71	4.29	0.146	0.169	
b4	2.59	3.43	0.102	0.135			ØΡ	3.56	3.66	0.14	0.144	
b5	2.59	3.38	0.102	0.133			Ø P1	-	7.39	-	0.291	
С	0.38	0.89	0.015	0.035			Q	5.31	5.69	0.209	0.224	
c1	0.38	0.84	0.015	0.033			R	4.52	5.49	0.178	0.216	
D	19.71	20.70	0.776	0.815	3		S	5.51	BSC	0.217	' BSC	
D1	13.08	-	0.515	-	4							

#### Notes

<sup>(1)</sup> Dimensioning and tolerancing per ASME Y14.5M-1994

(2) Contour of slot optional

(3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body

(4) Thermal pad contour optional with dimensions D1 and E1

<sup>(5)</sup> Lead finish uncontrolled in L1

<sup>(6)</sup> Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")

<sup>(7)</sup> Outline conforms to JEDEC<sup>®</sup> outline TO-247 with exception of dimension Q

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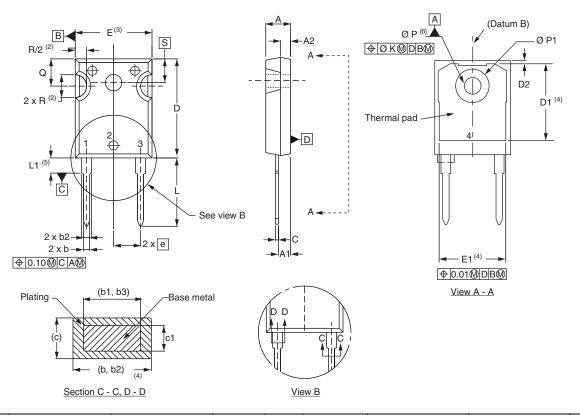
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**Vishay Semiconductors** 

TO-247AC 2L

#### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIM	IETERS	INC	HES	NOTES	NOTES		MILLIN	IETERS	INC	HES	NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES		SYMBOL	MIN.	MAX.	MIN.	MAX.	NOTES
A	4.65	5.31	0.183	0.209			E	15.29	15.87	0.602	0.625	3
A1	2.21	2.59	0.087	0.102			E1	13.46	-	0.53	-	
A2	1.17	1.37	0.046	0.054			e	5.46	BSC	0.215	BSC	
b	0.99	1.40	0.039	0.055		ØK 0.254 0.010		)10				
b1	0.99	1.35	0.039	0.053			L	14.20	16.10	0.559	0.634	
b2	1.65	2.39	0.065	0.094			L1	3.71	4.29	0.146	0.169	
b3	1.65	2.34	0.065	0.092			ØР	3.56	3.66	0.14	0.144	
С	0.38	0.89	0.015	0.035			Ø P1	-	7.39	-	0.291	
c1	0.38	0.84	0.015	0.033			Q	5.31	5.69	0.209	0.224	
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D1	13.08	-	0.515	-	4		S	5.51 BSC 0.217 BSC				
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